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(12) **United States Design Patent**
Hong et al.

(10) **Patent No.:** **US D961,556 S**
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- (54) **WIRELESS EARPHONE**
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- (**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(74) *Attorney, Agent, or Firm* — NSIP Law

(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; 128/864-866;
381/380-381, 374, 322, 328, 330;
455/90.3, 575.1, 569.1
CPC H04R 1/10; H04R 1/1033; H04R 1/1016;
H04R 1/1066; H04R 5/033; H04R
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11/08
See application file for complete search history.

(57) **CLAIM**

We claim the ornamental design for a wireless earphone, as shown and described.

DESCRIPTION

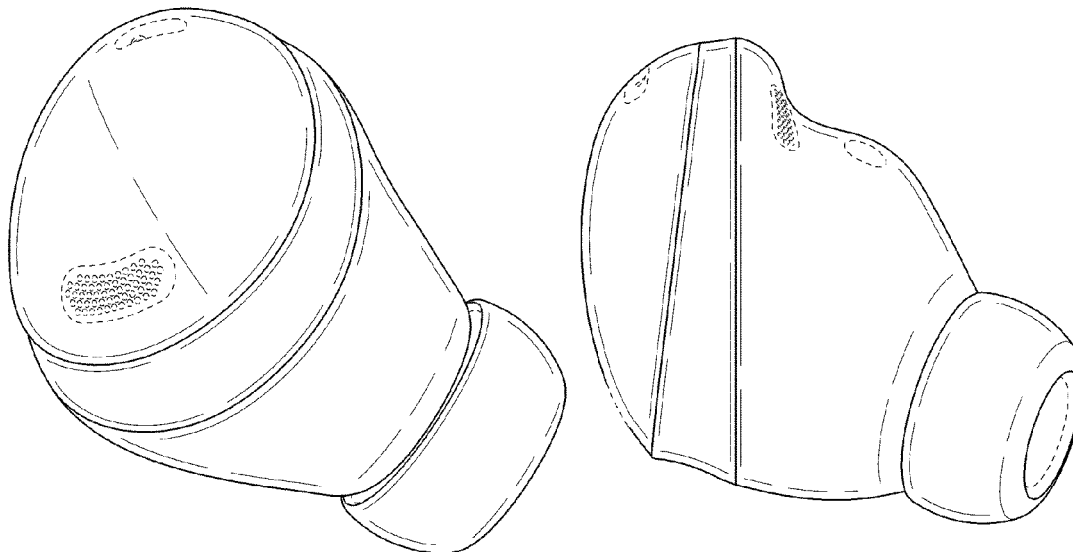
FIG. 1 is a front perspective view of a wireless earphone showing our new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a left-side view thereof;
FIG. 5 is a right-side view thereof;
FIG. 6 is a top view thereof;
FIG. 7 is a bottom view thereof; and,
FIG. 8 is a rear perspective view thereof.
The broken lines in the figures depict portions of a wireless earphone which form no part of the claimed design.

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1 Claim, 5 Drawing Sheets



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FIG.1

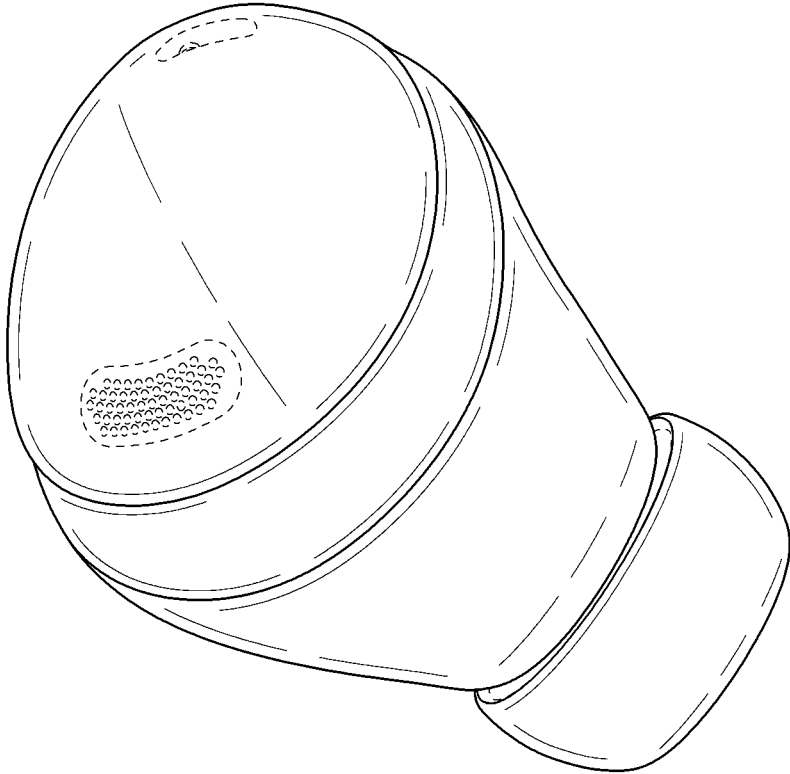


FIG.2

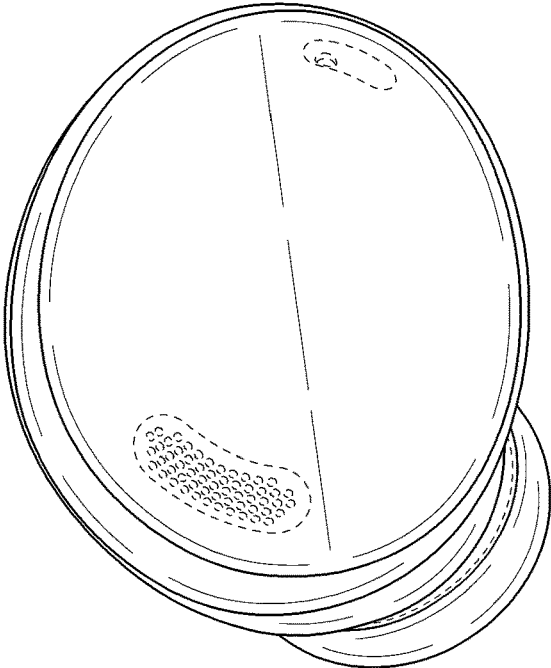


FIG.3

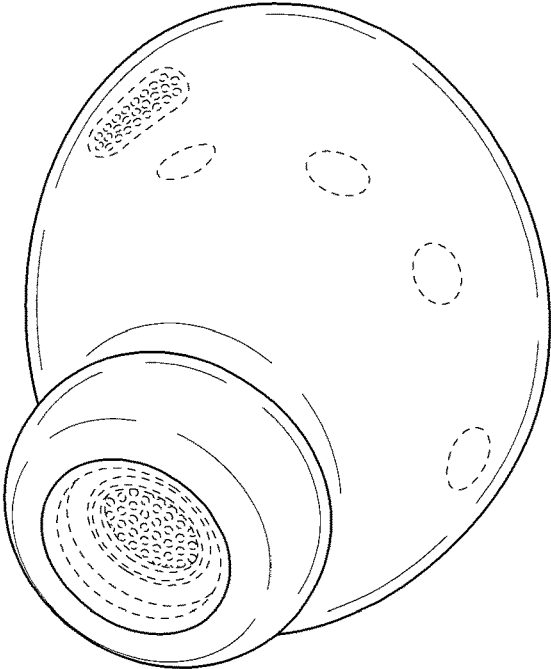


FIG.4

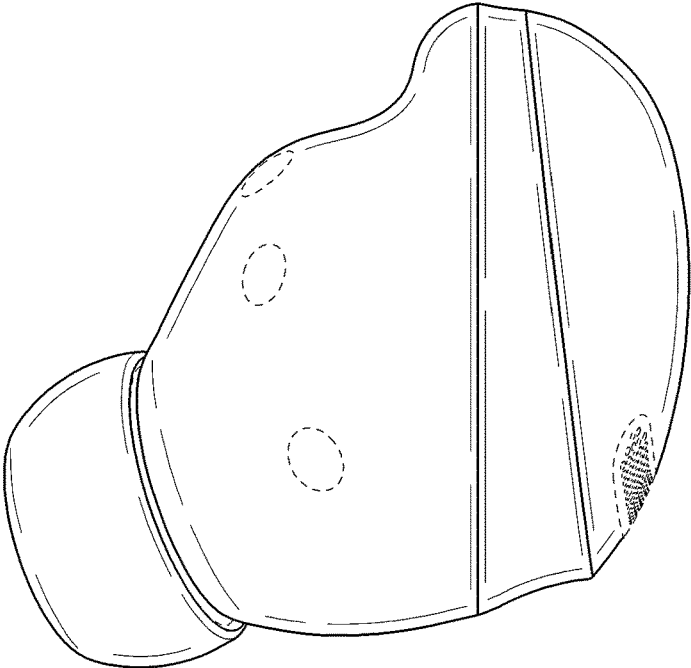


FIG.5

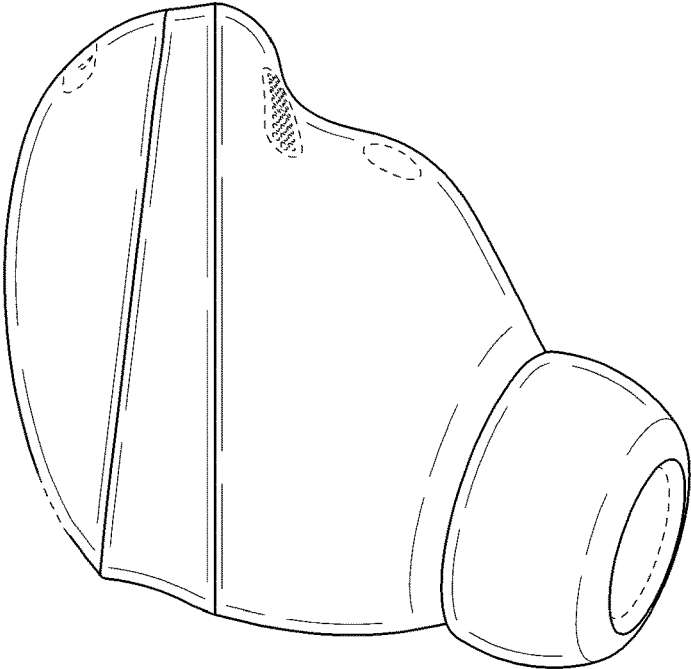


FIG.6

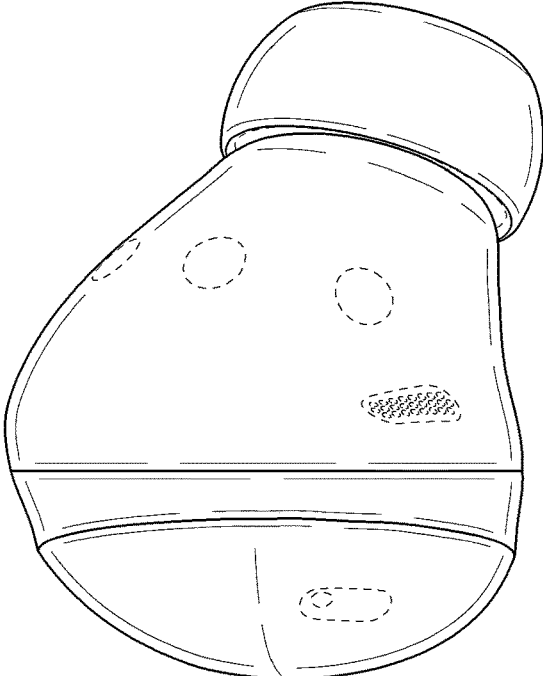


FIG.7

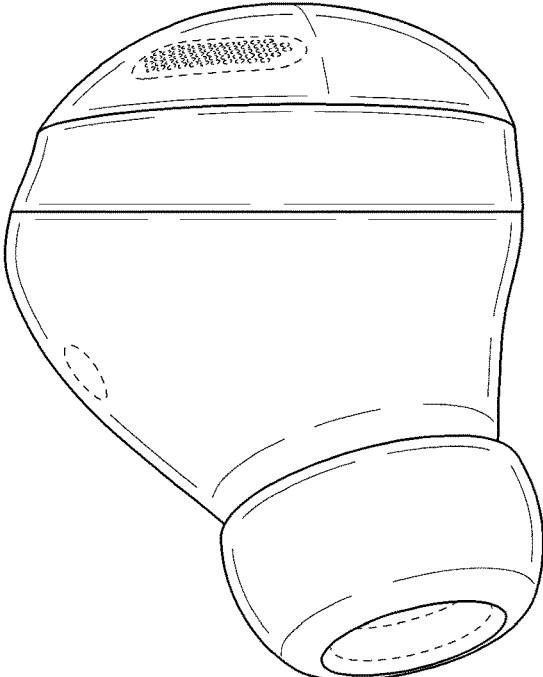


FIG.8

